

## • General Description

The AGM03N85H combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{\text{DS(ON)}}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- Low R<sub>DS(ON)</sub> to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

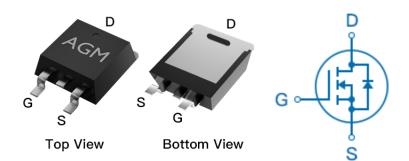
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## **Product Summary**

BVDSS	RDSON	ID
85V	2.8mΩ	140A

#### **TO-263 Pin Configuration**



**Package Marking and Ordering Information** 

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM03N85H	AGM03N85H	TO-263	330mm	25mm	800

## Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	85	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	140	А
	Drain Current-Continuous(Tc=100℃)	116	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	560	А
PD	Maximum Power Dissipation(Tc=25℃)	227	W
	Maximum Power Dissipation(Tc=100℃)	90	W
EAS	Avalanche energy (Note 3)	1156	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		62	°C/W
RøJC	Thermal Resistance Junction-Case <sup>1</sup>		0.55	°C/W



Table 3. Electrical Characteristics (TJ=25<sup>o</sup>Cunless otherwise noted)

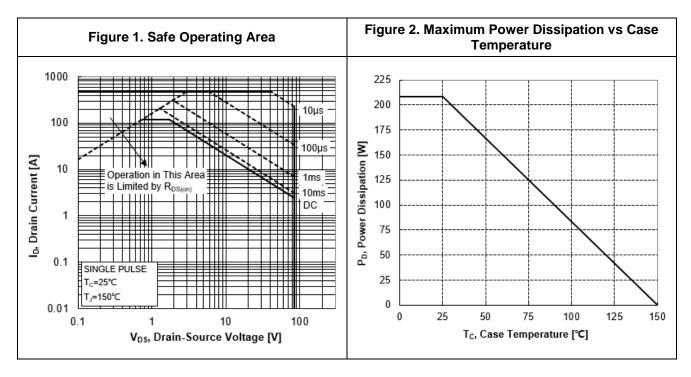
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	85			V
IDSS	Zero Gate Voltage Drain Current	VDS=85V,VGS=0V			1	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.0	3.0	4.0	V
gFS	Forward Transconductance	VDS=10V,ID=15A		10		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		2.8	3.4	mΩ
Dynamic (	Characteristics					
Ciss	Input Capacitance	VDS=50V,VGS=0V,		6890		pF
Coss	Output Capacitance	F=1MHZ		2500		pF
Crss	Reverse Transfer Capacitance			140		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz				Ω
Switching	Times					
td(on)	Turn-on Delay Time	VGS=10V,VDS=50V ID=10A,RGEN=3Ω		29		nS
tr	Turn-on Rise Time			33		nS
td(off)	Turn-Off Delay Time			48		nS
tf	Turn-Off Fall Time			26		nS
Qg	Total Gate Charge	VGS=10V, VDS=50V, ID=12A		102		nC
Qgs	Gate-Source Charge			30		nC
Qgd	Gate-Drain Charge	- 15-12/		20		nC
Source-Di	rain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				140	Α
VSD	Forward on Voltage	VGS=0V,IS=20A			1.2	V
trr	Reverse Recovery Time	IS=20A , dI/dt=100A/μs ,		82		ns
Qrr	Reverse Recovery Charge	TJ=25℃		170		nc

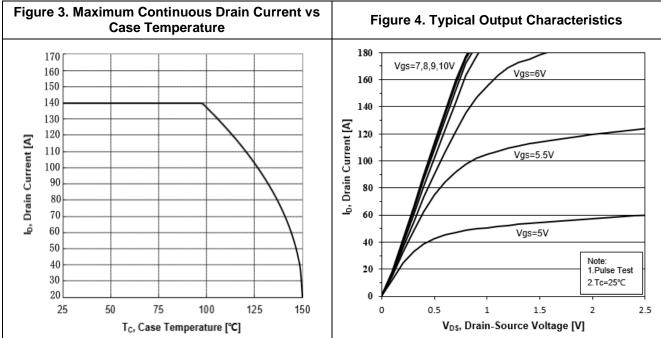
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

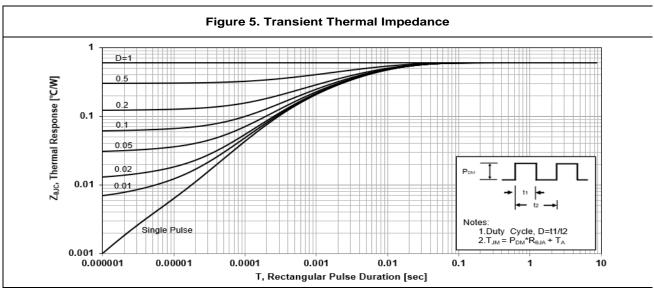
Notes 3.EAS condition: TJ=25°C,VDD=40V,Vgs=10V, ID=68A, L=0.5mH,RG=25ohm

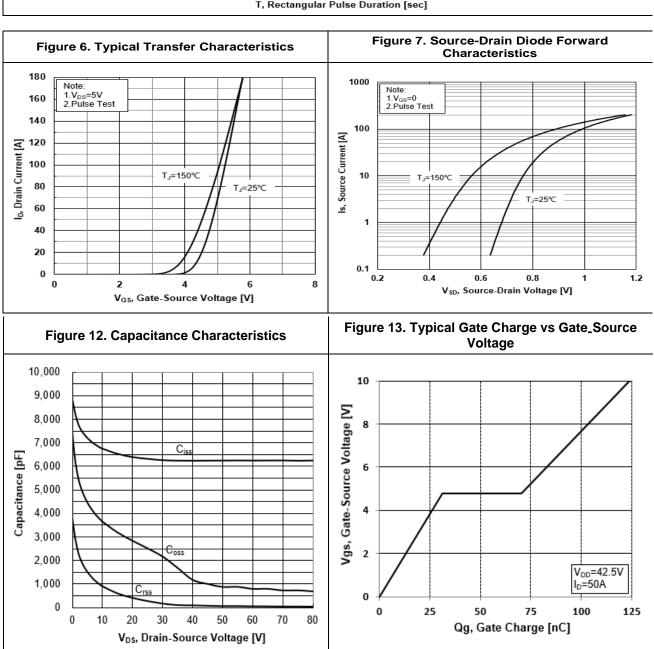






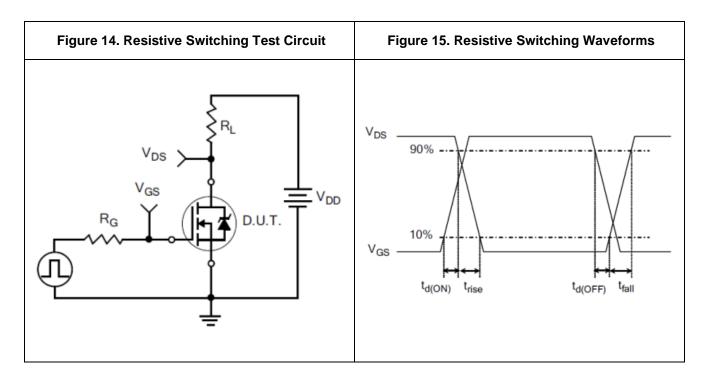


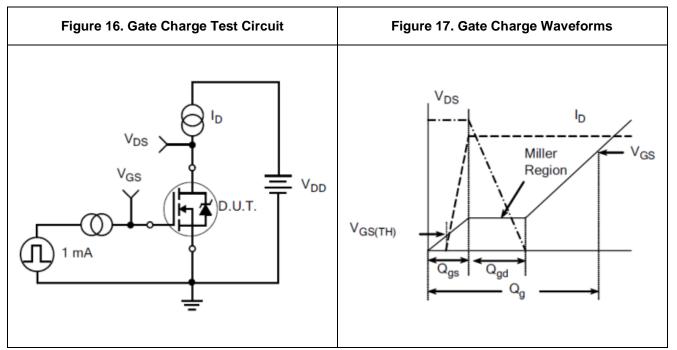




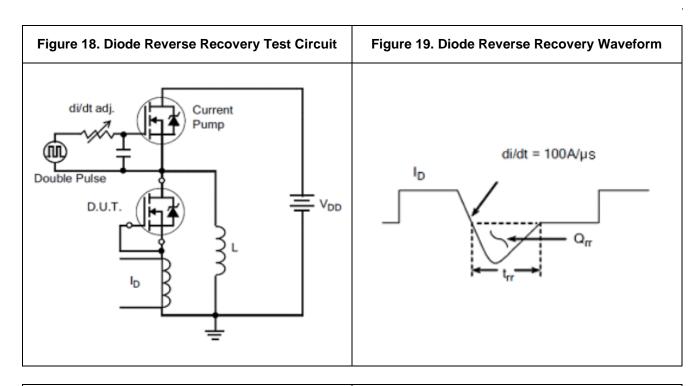


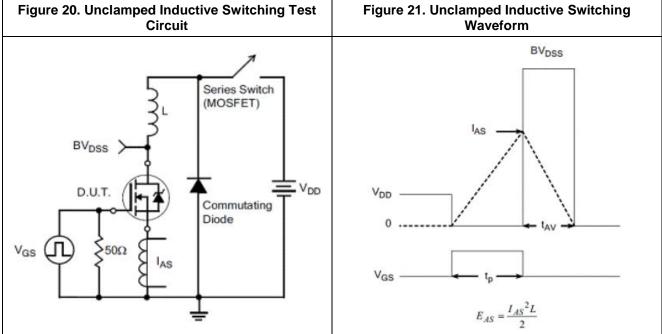
# **Test Circuit and Waveform**





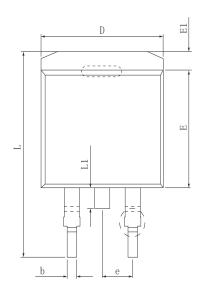


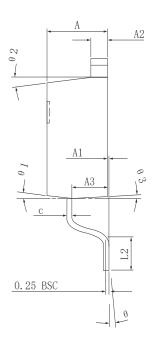


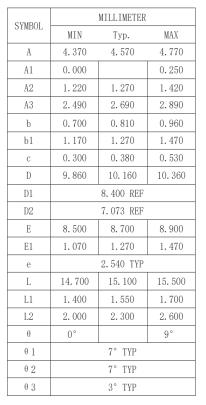


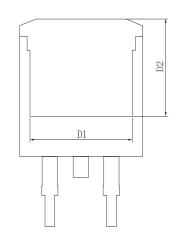


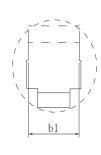
# •Dimensions (TO-263)

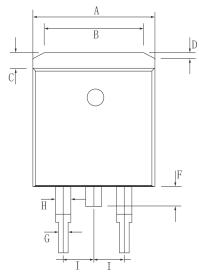


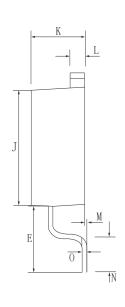








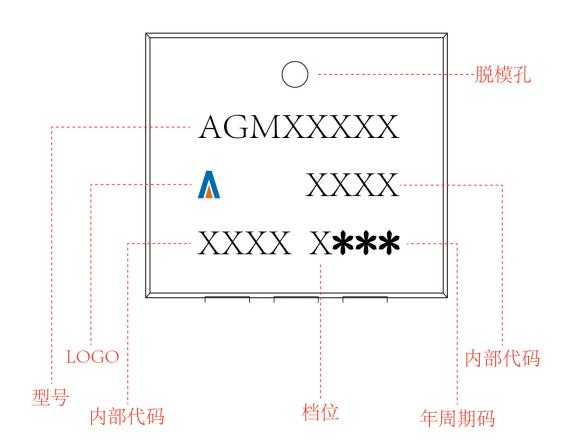




Dim.	Min.	Max.	
A	9.8	10. 2	
В	6. 1	6. 7	
С	1.1	1.4	
D	0.5	1.0	
Е	4.6	5.0	
F	1.4	1.6	
G	0.7	0.9	
Н	1. 17	1. 37	
Ι	Тур2. 54		
J	9	9. 2	
K	4.3	4. 7	
L	1. 25	1.35	
M	0.02	0.23	
N	2.2	2.8	
0	0.45	0. 55	
All Dimensions in millimeter			



TO-263 Marking Instructions:





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